

Description

The HM6910 uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a Battery protection or in other Switching application.

General Features

 $V_{DS} = 60V I_{D} = 10A$

 $R_{DS(ON)}$ < 49m Ω @ V_{GS} =10V

Application

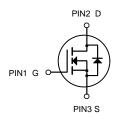
Battery protection

Load switch

Uninterruptible power supply







N-Channel MOSFET

Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
HM6910	SOT-89	10N06	1000

Absolute Maximum Ratings (T_C=25°C unless otherwise specified)

Symbol	Parameter		Max.	Units
V _{DSS}	Drain-Source Voltage		60	V
V _{GSS}	Gate-Source Voltage		±20	V
I_	Continuous Drain Current	T _C = 25℃	10	А
I _D		T _C = 100 ℃	6.8	А
I _{DM}	Pulsed Drain Current note1		30	Α
EAS	Single Pulsed Avalanche Ene	ergy ^{note2}	6.3	mJ
P _D	Power Dissipation	T _C = 25°C	4	W
R ₀ JC	Thermal Resistance, Junction to Case		63	°C/W
T _J , T _{STG}	Operating and Storage Temp	erature Range	-55 to +175	°C



Electrical Characteristics (T_J=25°C unless otherwise specified)

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
Off Charac	cteristic		-			
V _{(BR)DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250μA	60	-	_	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =60V, V _{GS} =0V,	-	-	1.0	μΑ
I _{GSS}	Gate to Body Leakage Current	V _{DS} =0V, V _{GS} =±20V	-	-	±100	nA
On Charac	cteristics					
$V_{GS(th)}$	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250μA	1	1.6	2.5	V
D	Static Drain-Source on-Resistance	V _{GS} =10V, I _D =15A	-	40	49	
$R_{DS(on)}$	note3	V _{GS} =4.5V, I _D =10A	-	45	63	mΩ
Dynamic 0	Characteristics					
C _{iss}	Input Capacitance	\\ -05\\\\ -0\\	-	825	-	pF
Coss	Output Capacitance	V _{DS} =25V, V _{GS} =0V, f=1.0MHz	-	49	-	pF
C _{rss}	Reverse Transfer Capacitance	I – I.UIVIMZ	-	41	-	pF
Qg	Total Gate Charge	\/ -20\/ -4.54	-	14	-	nC
Q_{gs}	Gate-Source Charge	V_{DS} =30V, I_{D} =4.5A, V_{GS} =10V	-	2.9	-	nC
Q_{gd}	Gate-Drain("Miller") Charge	VGS-10V	-	5.2	_	nC
Switching	Characteristics					
t _{d(on)}	Turn-on Delay Time	\/ 20\/L 0A	-	5	-	ns
t _r	Turn-on Rise Time	V _{DS} =30V,I _D =2A,	-	2.6	_	ns
t _{d(off)}	Turn-off Delay Time	$R_L=6.7\Omega, R_G=3\Omega,$ $V_{GS}=10V$	-	16.1	_	ns
t _f	Turn-off Fall Time	VGS-10V	-	2.3	-	ns
Drain-Sou	rce Diode Characteristics and Maxim	um Ratings				
Is	Maximum Continuous Drain to Source Diode Forward Current		-	-	10	Α
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current		-	-	30	Α
V_{SD}	Drain to Source Diode Forward Voltage	V _{GS} =0V, I _S =15A	-	-	1.2	٧
trr	Body Diode Reverse Recovery Time	Body Diode Reverse Recovery Time		35	-	ns
Qrr	Body Diode Reverse Recovery Charge	T _J =25℃,I _F =15A, dI/dt=100A/µs	-	53	-	nC

Notes:1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature

^{2.} EAS condition : T_J=25 $^{\circ}\text{C}$,V_DD=30V,V_G=10V,L=0.5mH,Rg=25 Ω ,I_AS=6.1A

^{3.} Pulse Test: Pulse Width≤300µs, Duty Cycle≤0.5%



Typical Performance Characteristics

Figure1: Output Characteristics

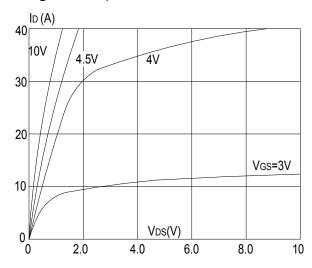


Figure 3:On-resistance vs. Drain Current

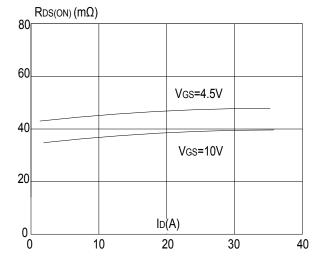


Figure 5: Gate Charge Characteristics

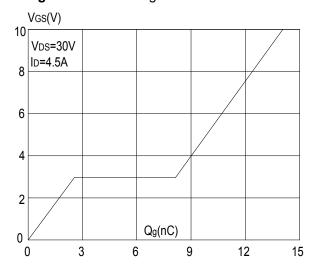


Figure 2: Typical Transfer Characteristics

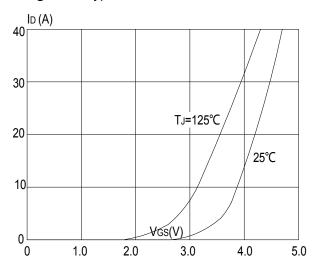


Figure 4: Body Diode Characteristics

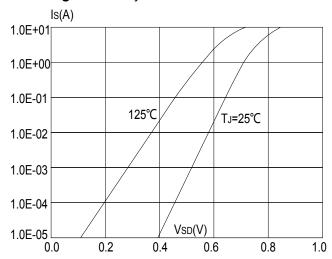


Figure 6: Capacitance Characteristics

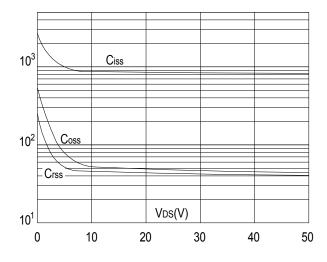




Figure 7: Normalized Breakdown Voltage vs. Junction Temperature

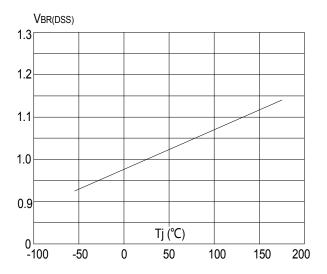


Figure 9: Maximum Safe Operating Area

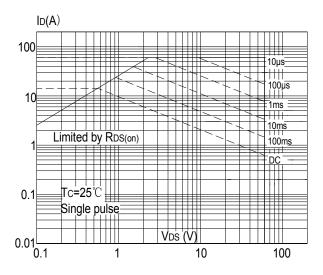


Figure.11: Maximum Effective
Transient Thermal Impedance, Junction-to-Case

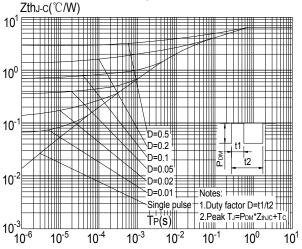


Figure 8: Normalized on Resistance vs. Junction Temperature

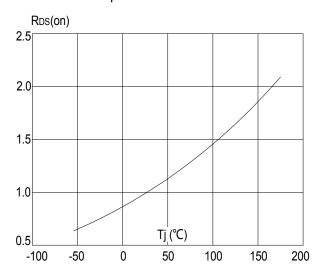
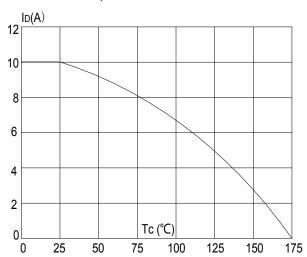
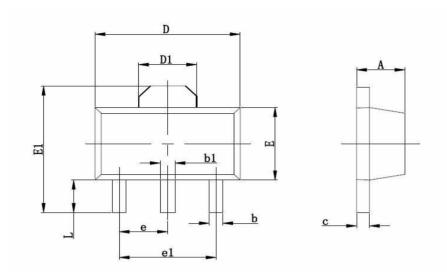


Figure 10: Maximum Continuous Drain Current vs. Case Temperature





SOT-89 Package Outline Dimensions



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
Α	1.400	1.600	0.055	0.063
b	0.350	0.520	0.013	0.197
b1	0.400	0.580	0.016	0.023
С	0.350	0.440	0.014	0.017
D	4.400	4.600	0.173	0.181
D1	1.550 REF		0.061 REF	
E	2.350	2.550	0.091	0.102
E1	3.940	4.250	0.155	0.167
е	1.500 TYP		0.060TYP	
e1	3.000 TYP		0.118TYP	
L	0.900	1.100	0.035	0.047



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